



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



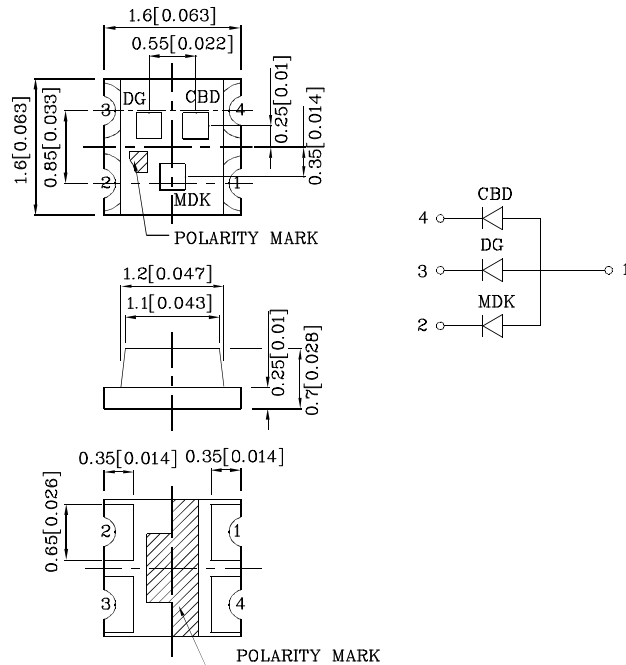
Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

Package Schematics



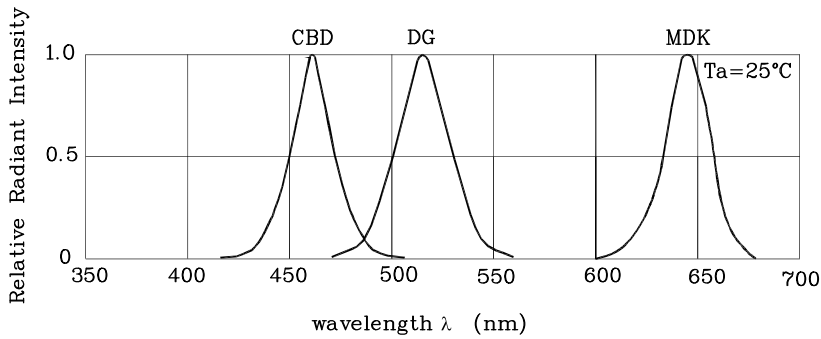
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.2(0.008)$ unless otherwise noted.
3. Specifications are subject to change without notice.

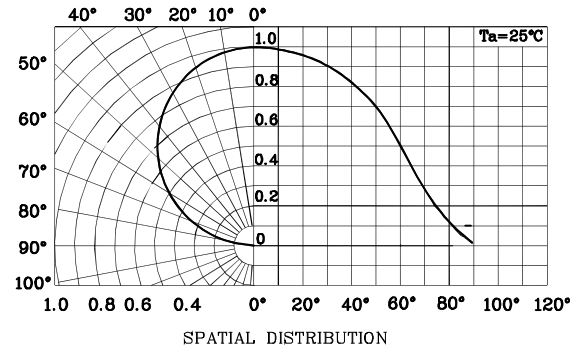
Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)		MDK (AlGaInP)	DG (InGaIn)	CBD (InGaIn)	Unit	Operating Characteristics ($T_A=25^\circ\text{C}$)		MDK (AlGaInP)	DG (InGaIn)	CBD (InGaIn)	Unit
Reverse Voltage	V_R	5	5	5	V	Forward Voltage (Typ.) ($I_F=20\text{mA}$)	V_F	1.95	3.3	3.3	V
Forward Current	I_F	30	25	30	mA	Forward Voltage (Max.) ($I_F=20\text{mA}$)	V_F	2.5	4.1	4.0	V
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	185	150	150	mA	Reverse Current (Max.) ($V_R=5\text{V}$)	I_R	10	50	50	μA
Power Dissipation	P_D	75	102.5	120	mW	Wavelength of Peak Emission (Typ.) ($I_F=20\text{mA}$)	λ_P	645*	515*	460*	nm
Electrostatic Discharge Threshold (HBM)	-	-	450	250	V	Wavelength of Dominant Emission (Typ.) ($I_F=20\text{mA}$)	λ_D	630*	525*	465*	nm
Operating Temperature	T_A	-40 ~ +85			°C	Spectral Line Full Width At Half-Maximum (Typ.) ($I_F=20\text{mA}$)	$\Delta\lambda$	28	30	25	nm
Storage Temperature	T_{stg}					Capacitance (Typ.) ($V_F=0\text{V}$, $f=1\text{MHz}$)	C	35	45	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* ($I_F=20\text{mA}$) mcd		Wavelength CIE127-2007* nm λ_P	Viewing Angle 2 θ 1/2
				min.	typ.		
XZMDKDG CBD110W	Red	AlGaInP	Water Clear	40*	79*	645*	120°
	Green	InGaIn		200*	297*	515*	
	Blue	InGaIn		40*	69*	460*	

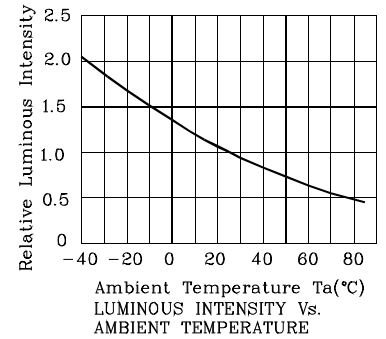
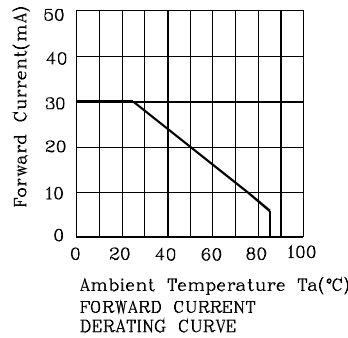
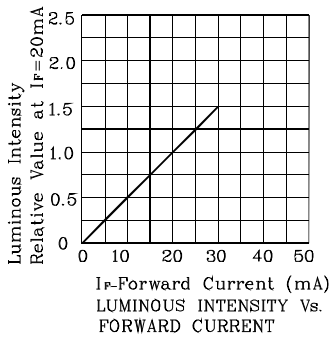
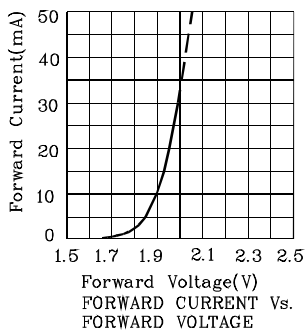
*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.



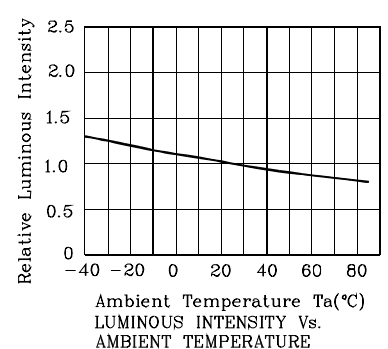
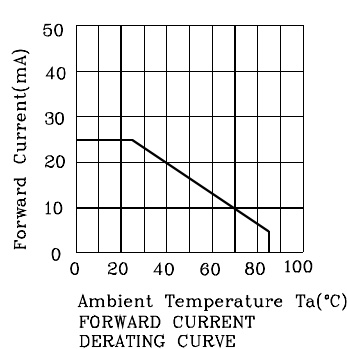
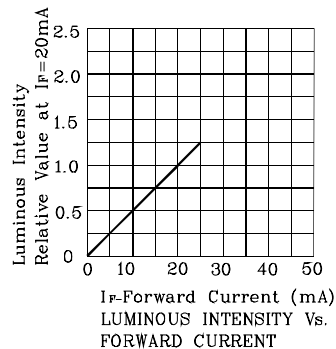
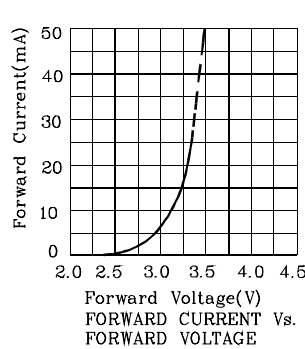
RELATIVE INTENSITY Vs. CIE WAVELENGTH



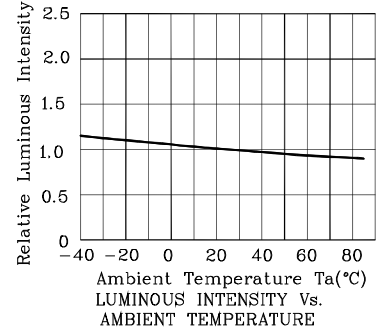
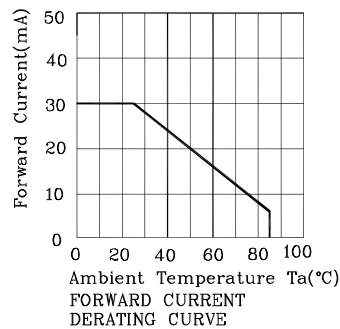
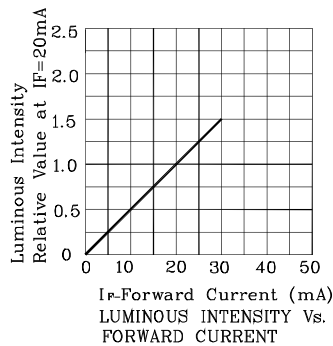
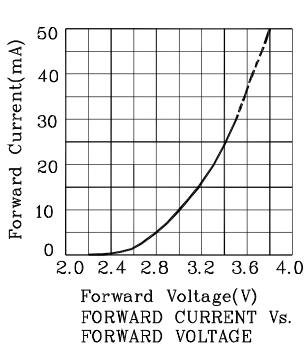
❖ MDK



❖ DG



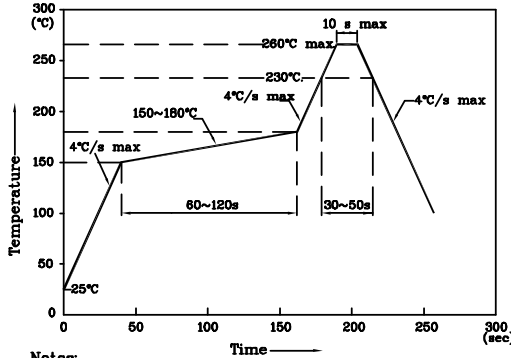
❖ CBD



❖ LED is recommended for reflow soldering and soldering profile is shown below.

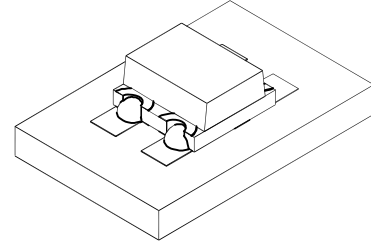
❖ The device has a single mounting surface. The device must be mounted according to the specifications.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

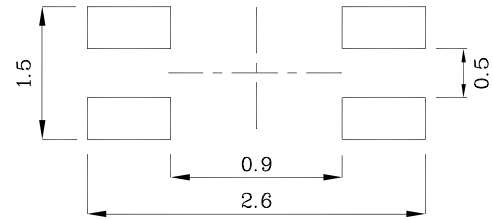


Notes:

1. Maximum soldering temperature should not exceed 260°C
2. Recommended reflow temperature: 145°C-260°C
3. Do not put stress to the epoxy resin during high temperatures conditions

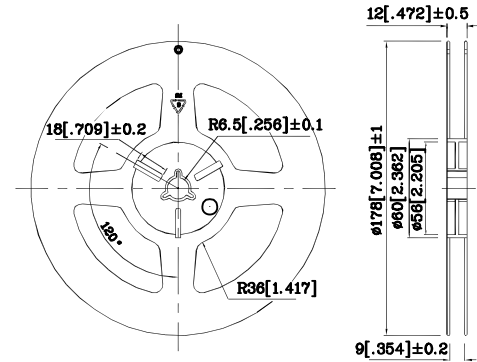
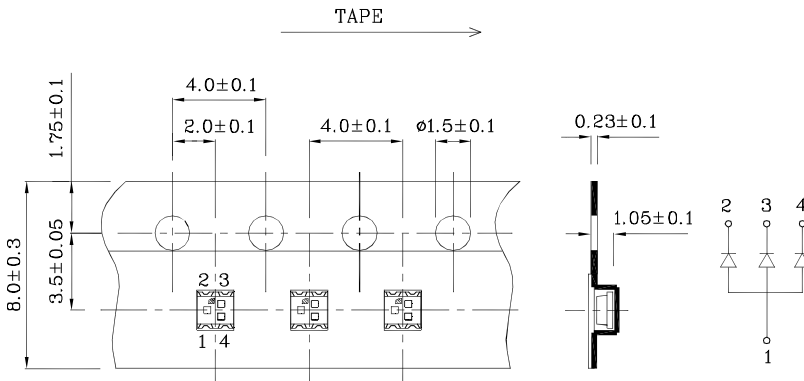


❖ Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



❖ Tape Specification (Units : mm)

❖ Reel Dimension



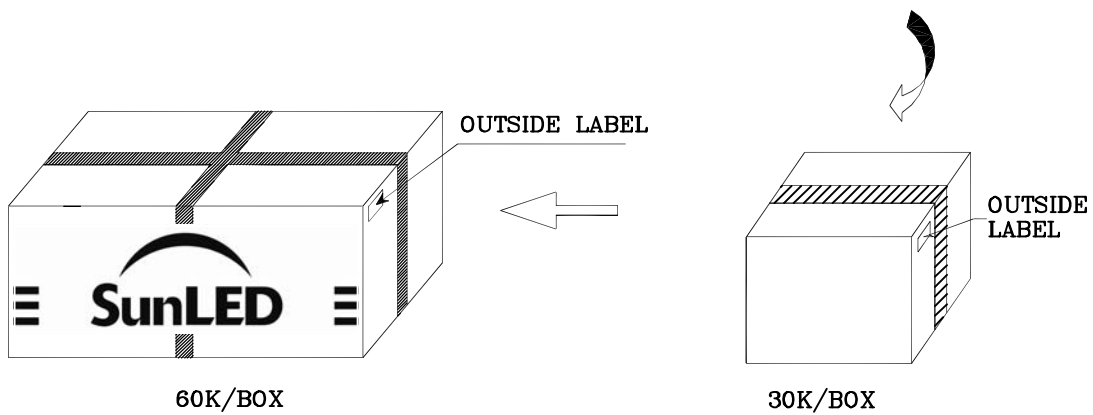
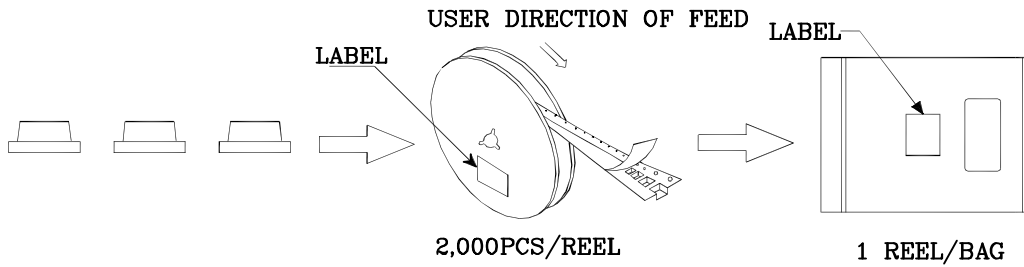
Remarks:


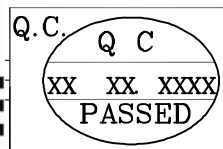

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

PACKING & LABEL SPECIFICATIONS



		
P/NO : XZxxx110x		
QTY : 2,000 pcs	CODE: XXX	
S/N : XX		
LOT NO :		
 XXXXXXXXXXXXXXXXXXXX		
RoHS Compliant		

TERMS OF USE

1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
2. Contents within this document are subject to improvement and enhancement changes without notice.
3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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6. Additional technical notes are available at <http://www.SunLEDusa.com/TechnicalNotes.asp>